SMBJ130A-E

Surface Mount Transient Voltage Suppressors

Pppm: 600W

IFSM: 100A

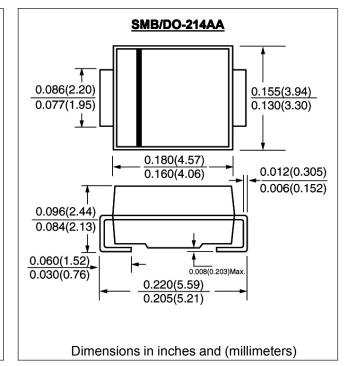


FEATURE

Low profile package Ideal for surface mount pick and place applications Excellent clamping capability Very fast response time Low incremental surge resistance Glass passivated chip junction High temperature soldering guaranteed 260°C/10sec/at terminals

MECHANICAL DATA

Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
Case: Molded with UL-94 Class V-0 recognized Halogen Free Epoxy
Polarity: color band denotes cathode end
Mounting position: any
Marking: TB130A



MAXIMUM RATINGS

Parameter	Symbol	SMBJ130A-E	units
Peak pulse power dissipation with a 10/1000 μs waveform $^{(1,2)}$ (Fig. 1)	P _{PPM}	600	W
Peak pulse current with a 10/1000 µs waveform ⁽¹⁾	I _{PPM}	2.9	A
Breakdown Voltage at I _T =1mA	V _{BR}	144min 159max	V
Maximum Reverse Leakage at V_{WM} =130V	I _R	1.0	μA
Maximum Clamping Voltage at I _{PPM}	V _C	209	V
Peak forward surge current 8.3 ms single half sine-wave uni- directional only ⁽²⁾	I _{FSM}	100	A
Maximum instantaneous forward voltage at 50A for uni- directional only	V _F	3.5	V
Typical thermal resistance, junction-to-lead	Rth(jl)	20	°C/M
Typical thermal resistance, junction-to—ambient ⁽³⁾	Rth(ja)	100	°C/M
Operating junction and Storage temperature range	Tj, Tstg	-55 to +150	°C

(1) Non-repetitive current pulse, per Fig. 3 and derated above TA = 25 °C per Fig. 2

(2) Mounted on 0.2×0.2"(5.0×5.0mm) copper pads to each terminal

(3) Mounted on minimum recommended pad layout

www.gulfsemi.com

RATINGS AND CHARACTERISTIC CURVES SMBJ130A-E

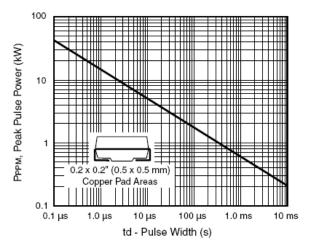
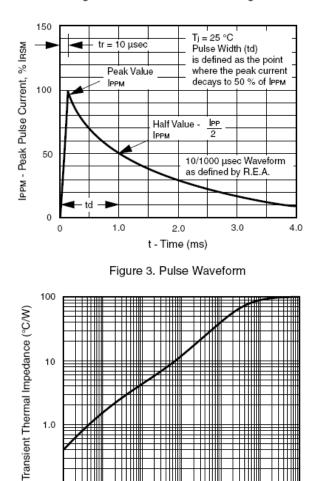


Figure 1. Peak Pulse Power Rating Curve



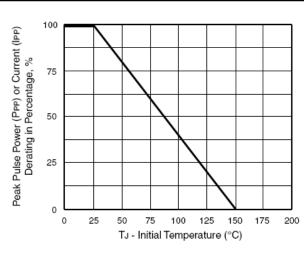
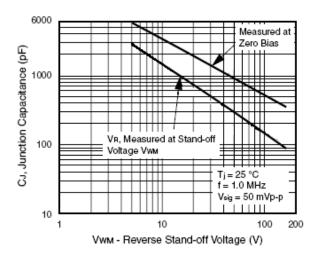


Figure 2. Pulse Power or Current versus Initial Junction Temperature





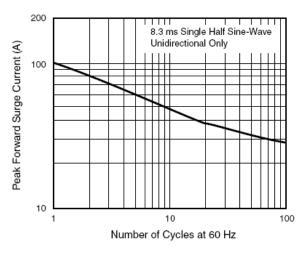


Figure 5. Typical Transient Thermal Impedance

1.0

tp - Pulse Duration (s)

10

100

1000

Figure 6. Maximum Non-Repetitive Peak Forward Surge Current

0.1

0.001

0.01

0.1